

14 + 1 channel buffers for TFT-LCD panels

Datasheet – production data

Features

- Wide supply voltage: 5.5 V to 16.8 V
- Low operating current: 6 mA typical at 25 °C
- Gain bandwidth product: 1 MHz
- High current COM amplifier: ± 100 mA output current
- Industrial temperature range: -40 °C to +85 °C
- Small package: TQFP48
- Automotive qualification

Application

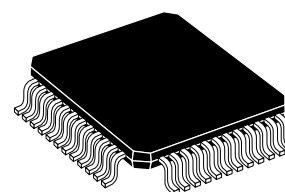
- TFT liquid crystal display (LCD)

Description

The TSL1014 device is composed of 14 + 1 channel buffers which are used to buffer the reference voltage for gamma correction in thin film transistor (TFT) liquid crystal displays (LCD).

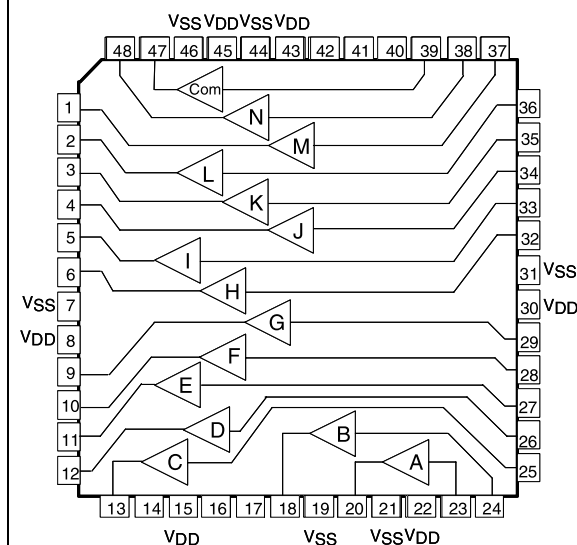
One “COM” amplifier is able to deliver high output current value, up to ± 100 mA. Amplifiers A and B feature positive single supply inputs for common mode voltage behavior. The amplifiers C to N inclusive, and the COM amplifier, feature negative single supply inputs and are dedicated to the highest and lowest gamma voltages.

The TSL1014 device is fully characterized and guaranteed over a wide industrial temperature range (-40 to +85 °C).



7 x 7 mm TQFP48

Pin connections (top view)



1 Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage ($V_{DD} - V_{SS}$)	18	V
V_{IN}	Input voltage	$V_{SS} - 0.5\text{ V to } V_{DD} + 0.5\text{ V}$	V
I_{OUT}	Output current (A to N buffers) Output current (COM buffer)	30 100	mA
I_{SC}	Short-circuit current (A to N buffers) Short-circuit current (COM buffer)	± 120 ± 300	mA
P_D	Power dissipation ⁽¹⁾ for TQFP48	1470	mW
R_{THJA}	Thermal resistance junction-to-ambient for TQFP48	85	°C/W
T_{LEAD}	Lead temperature (soldering 10 seconds)	260	°C
T_{STG}	Storage temperature	-65 to +150	°C
T_J	Junction temperature	150	°C
ESD	Human body model (HBM) ⁽²⁾	2000	V
	Machine model (MM) ⁽³⁾	200	
	Charged device model (CDM) ⁽⁴⁾	1500	

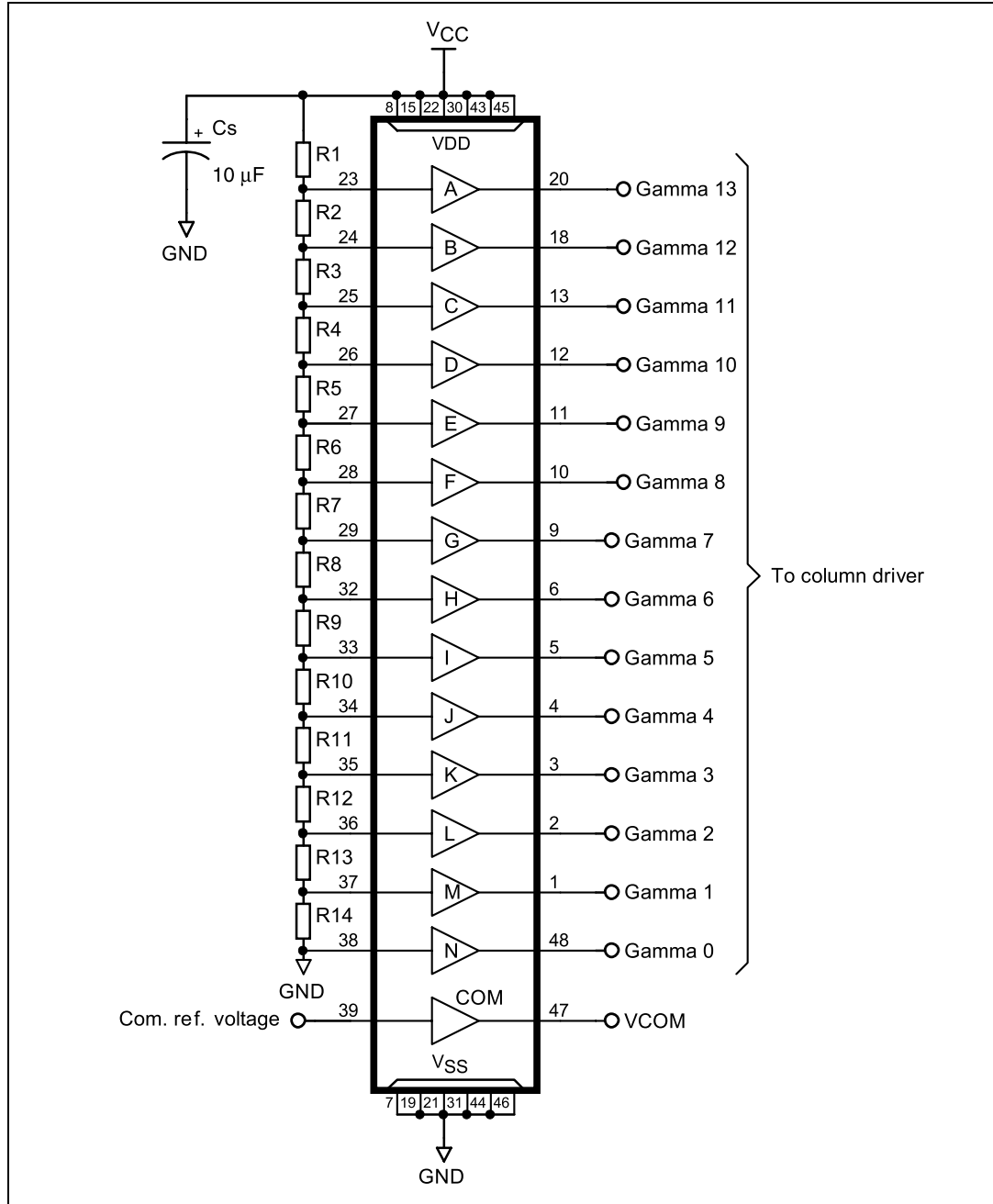
- P_D is calculated with $T_{amb} = 25\text{ °C}$, $T_J = 150\text{ °C}$ and $R_{THJA} = 85\text{ °C/W}$ for the TQFP48 package.
- Human body model: a 100 pF capacitor is charged to the specified voltage, then discharged through a 1.5 kW resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
- Machine model: a 200 pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 W). This is done for all couples of connected pin combinations while the other pins are floating.
- Charged device model: all pins and package are charged together to the specified voltage and then discharged directly to ground through only one pin.

Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage ($V_{DD} - V_{SS}$)	5.5 to 16.8	V
T_{amb}	Ambient temperature	-40 to +85	°C
V_{IN}	Input voltage (buffers A and B)	$V_{SS} + 1.5\text{ V to } V_{DD}$	V
	Input voltage (buffers C to N + COM)	$V_{SS}\text{ to } V_{DD} - 1.5\text{ V}$	

2 Typical application schematics

Figure 1. Typical application schematic for the TSL1014 device



Note that:

- Amplifiers **A** and **B** have their input voltage in the range $V_{SS} + 1.5\text{ V}$ to V_{DD} . This is why they must be used for high level gamma correction voltages.
- Amplifiers **C** to **N** have their input voltage in the range V_{SS} to $V_{DD} - 1.5\text{ V}$. This is why they must be used for medium-to-low level gamma correction voltages.
- Amplifier **COM** has its input voltage range from V_{SS} to $V_{DD} - 1.5\text{ V}$.

3 Electrical characteristics

Table 3. Electrical characteristics for TSL1014IF/TSL1014IFT
 $T_{amb} = 25\text{ }^{\circ}\text{C}$, $V_{DD} = +5\text{ V}$, $V_{SS} = -5\text{ V}$, $R_L = 10\text{ k}\Omega$, $C_L = 10\text{ pF}$
 (unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{IO}	Input offset voltage	$V_{ICM} = 0\text{ V}$			12	mV
ΔV_{IO}	Input offset voltage drift	$T_{Min} < T_{amb} < T_{Max}$		5		$\mu\text{V}/^{\circ}\text{C}$
I_{IB}	Input bias current	$V_{ICM} = 0\text{ V}$, buffers A and B $V_{ICM} = 0\text{ V}$, buffers C to N and COM			140 70	nA
R_{IN}	Input impedance			1		$\text{G}\Omega$
C_{IN}	Input capacitance			1.35		pF
V_{OL}	Output voltage low	$I_{OUT} = -5\text{ mA}$ Buffers C to L Buffers M, N and COM		-4.85 -4.92	-4.80 -4.85	V
V_{OH}	Output voltage high	$I_{OUT} = 5\text{ mA}$ for positive single supply buffers (A and B)	4.82	4.87		V
I_{OUT}	Output current	(A to N buffers)		± 30		mA
		COM buffer		± 100		
PSRR	Power supply rejection ratio	$V_{CC} = 6.5\text{ to }15.5\text{ V}$	80	100		dB
I_{CC}	Supply current	No load		6	8.4	mA
SR	Slew rate (rising and falling edge)	$-4\text{ V} < V_{OUT} < +4\text{ V}$ 20% to 80%		1		$\text{V}/\mu\text{s}$
t_s	Settling time	Settling to 0.1%, $V_{OUT} = 2\text{ V}$ step		5		μs
BW	Bandwidth at -3 dB	$R_L = 10\text{ k}\Omega$, $C_L = 10\text{ pF}$		2		MHz
G_m	Phase margin	$R_L = 10\text{ k}\Omega$, $C_L = 10\text{ pF}$		60		Degrees
C_s	Channel separation	$f = 1\text{ MHz}$		75		dB

Note: Limits are 100% production tested at 25 °C. Behavior at the temperature range limits is guaranteed through correlation and by design.

Table 4. Electrical characteristics for TSL1014IYFT (automotive grade)
 $T_{amb} = 25\text{ }^{\circ}\text{C}$, $V_{DD} = +5\text{ V}$, $V_{SS} = -5\text{ V}$, $R_L = 10\text{ k}\Omega$, $C_L = 10\text{ pF}$
 (unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{IO}	Input offset voltage	$V_{ICM} = 0\text{ V}$ $T_{Min} < T_{amb} < T_{Max}$			12	mV
ΔV_{IO}	Input offset voltage drift	$T_{Min} < T_{amb} < T_{Max}$		5		$\mu\text{V}/^{\circ}\text{C}$
I_{IB}	Input bias current	$V_{ICM} = 0\text{ V}$, buffers A and B $T_{Min} < T_{amb} < T_{Max}$ $V_{ICM} = 0\text{ V}$, buffers C to N and COM $T_{Min} < T_{amb} < T_{Max}$			140 280 70 140	nA
R_{IN}	Input impedance			1		$\text{G}\Omega$
C_{IN}	Input capacitance			1.35		pF
V_{OL}	Output voltage low	$I_{OUT} = -5\text{ mA}$ Buffers C to L $T_{Min} < T_{amb} < T_{Max}$ Buffers M, N and COM $T_{Min} < T_{amb} < T_{Max}$		-4.85 -4.92	-4.80 -4.76 -4.85 -4.83	V
V_{OH}	Output voltage high	$I_{OUT} = 5\text{ mA}$ for positive single-supply buffers (A and B) $T_{Min} < T_{amb} < T_{Max}$	4.82 4.80	4.87		V
I_{OUT}	Output current	(A to N buffers) COM buffer		± 30 ± 100		mA
PSRR	Power supply rejection ratio	$V_{CC} = 6.5\text{ to }15.5\text{ V}$ $T_{Min} < T_{amb} < T_{Max}$	80	100		dB
I_{CC}	Supply current	No load $T_{Min} < T_{amb} < T_{Max}$		6	8.4 9	mA
SR	Slew rate (rising and falling edge)	$-4\text{ V} < V_{OUT} < +4\text{ V}$ 20% to 80%		1		$\text{V}/\mu\text{s}$
t_s	Settling time	Settling to 0.1%, $V_{OUT} = 2\text{ V}$ step		5		μs
BW	Bandwidth at -3 dB	$R_L = 10\text{ k}\Omega$, $C_L = 10\text{ pF}$		2		MHz
G_m	Phase margin	$R_L = 10\text{ k}\Omega$, $C_L = 10\text{ pF}$		60		Degrees
C_s	Channel separation	$f = 1\text{ MHz}$		75		dB

Note: Limits are 100% production tested at 25 °C. Behavior at the temperature range limits is guaranteed through correlation and by design.

Figure 2. Supply current vs. supply voltage for various temperatures

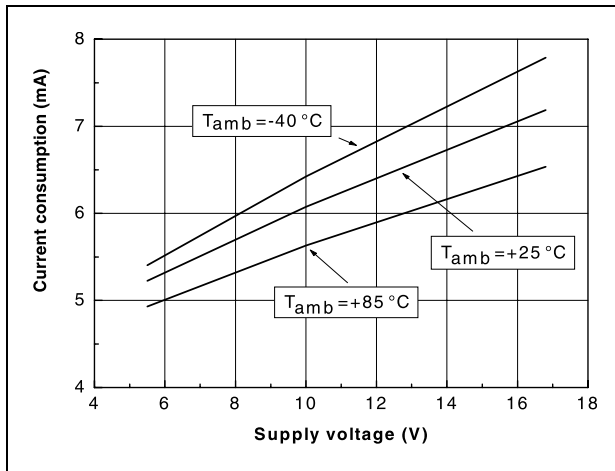


Figure 3. Output offset voltage (eq. V_{IO}) vs. temperature

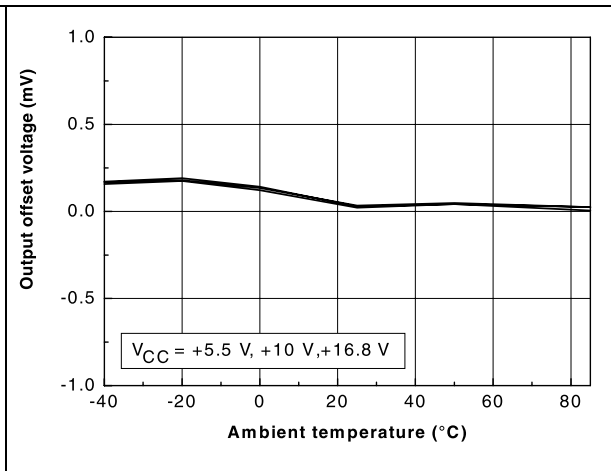


Figure 4. Input current (I_{IB}) vs. temperature, buffers A and B

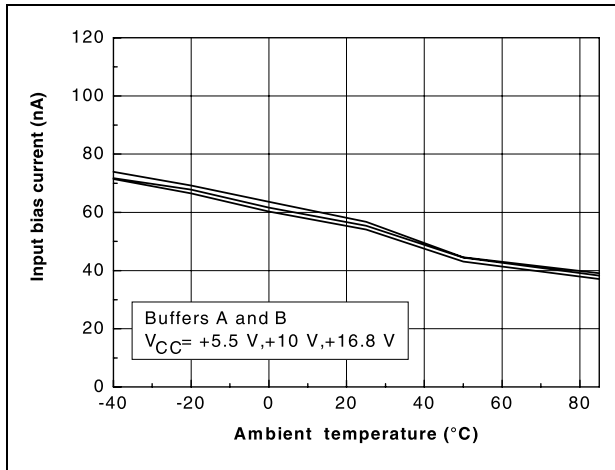


Figure 5. Input current (I_{IB}) vs. temperature, buffers C to COM

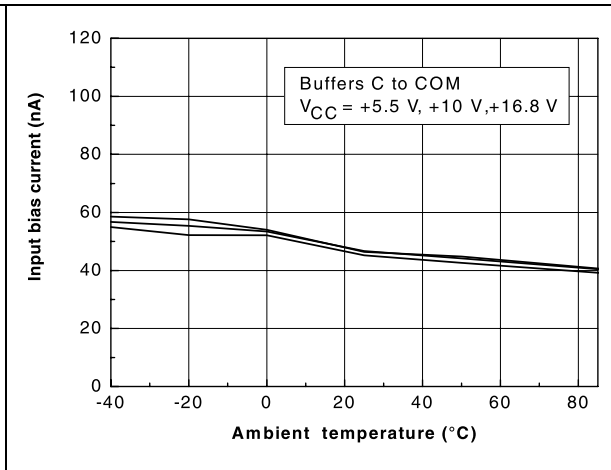


Figure 6. Output current capability vs. temperature, buffers A and B

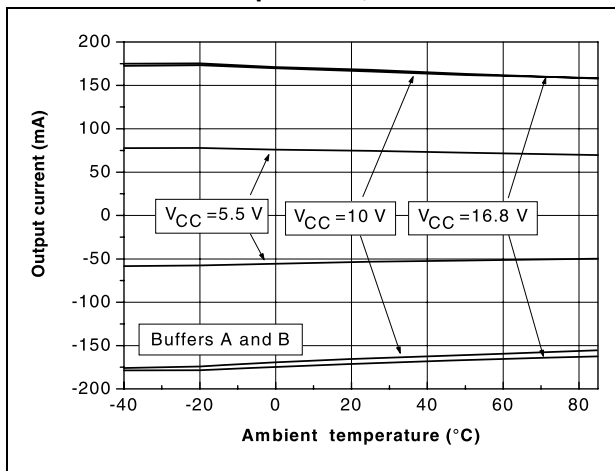


Figure 7. Output current capability vs. temperature, buffers C to N

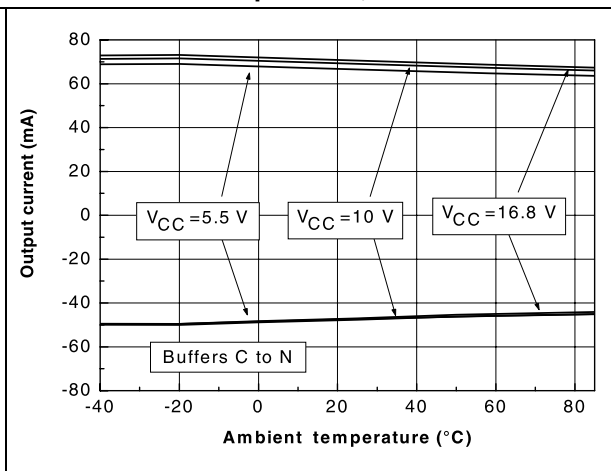


Figure 8. Output current capability vs. temperature, buffer COM

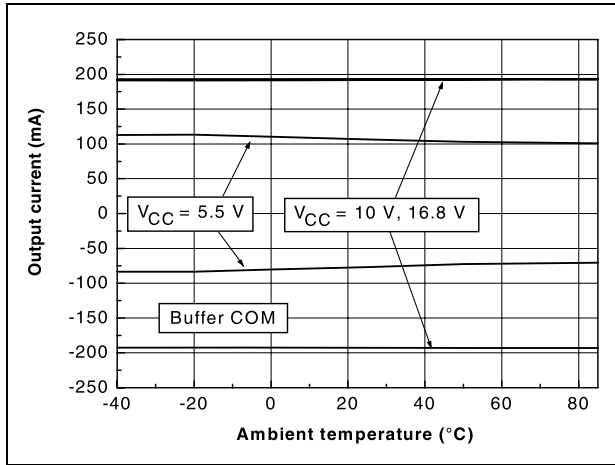


Figure 9. High level voltage drop vs. temperature

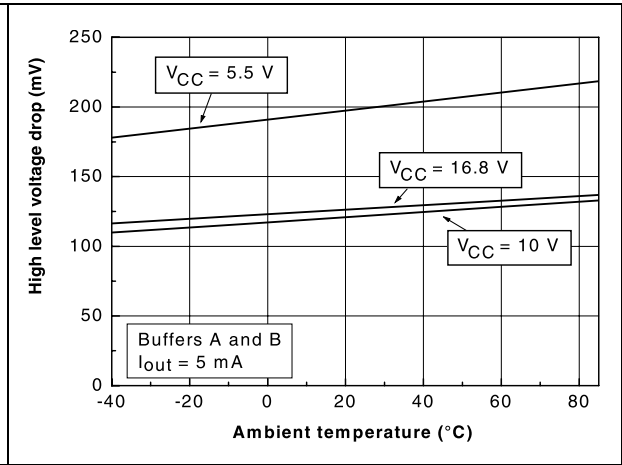


Figure 10. Low level voltage drop vs. temperature, buffers C to L

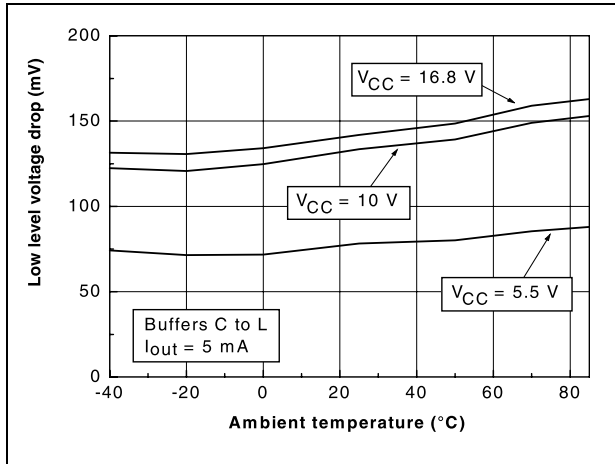


Figure 11. Low level voltage drop vs. temperature, buffers M, N, and COM

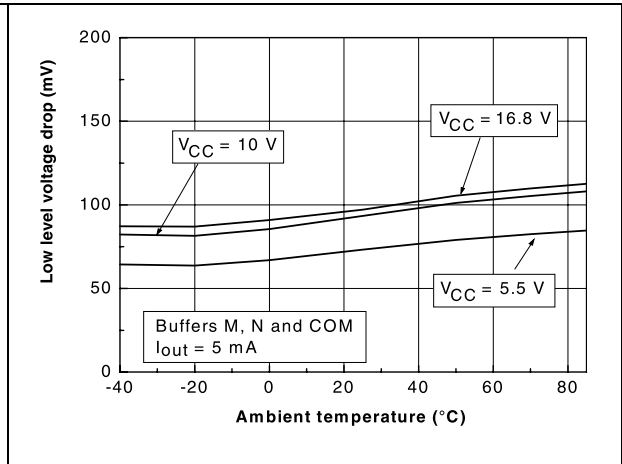


Figure 12. Voltage output high (VOH) vs. output current - buffers A and B, VCC = 5 V

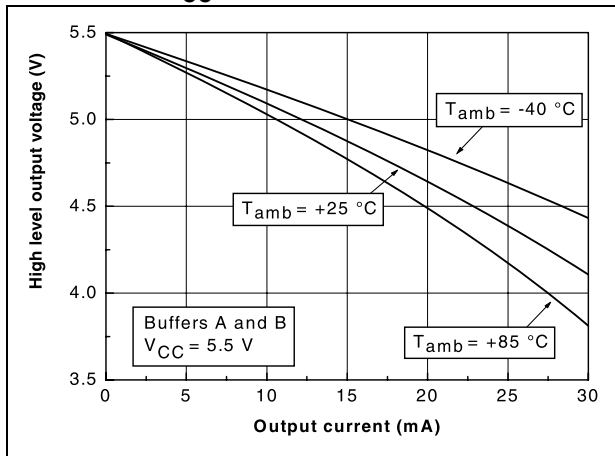


Figure 13. Voltage output high (VOH) vs. output current - buffers A and B, VCC = 10 V

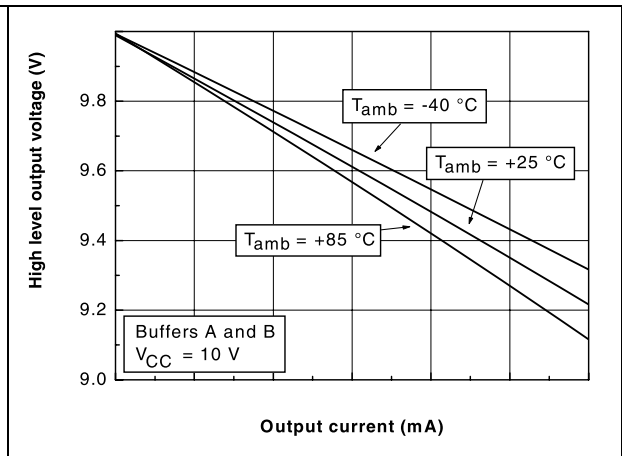


Figure 14. Voltage output high (V_{OH}) vs. output current - buffers A and B, $V_{CC} = 16.8\text{ V}$

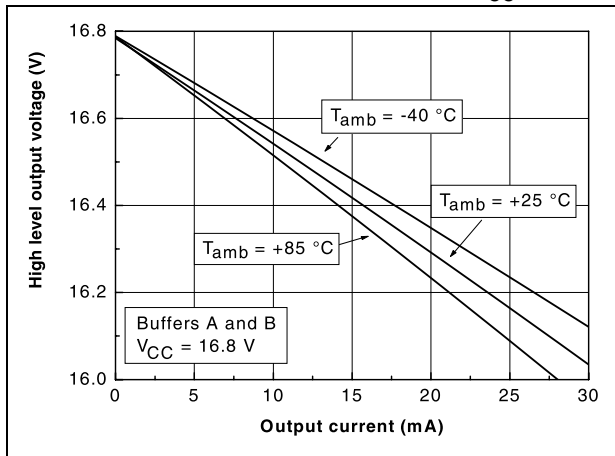


Figure 15. Voltage output low (V_{OL}) vs. output current - buffers C to L, $V_{CC} = 5.5\text{ V}$

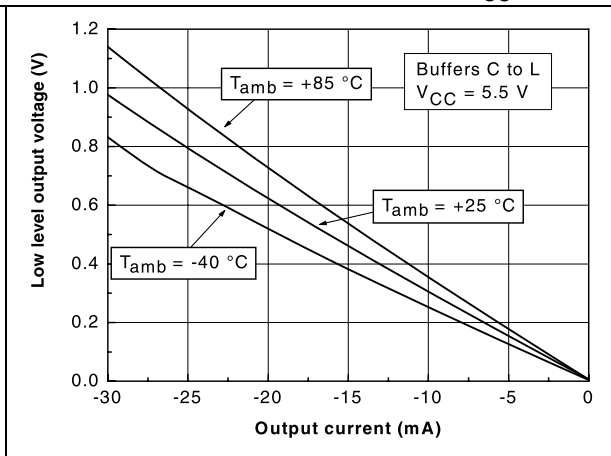


Figure 16. Voltage output low (V_{OL}) vs. output current - buffers C to L, $V_{CC} = 10\text{ V}$

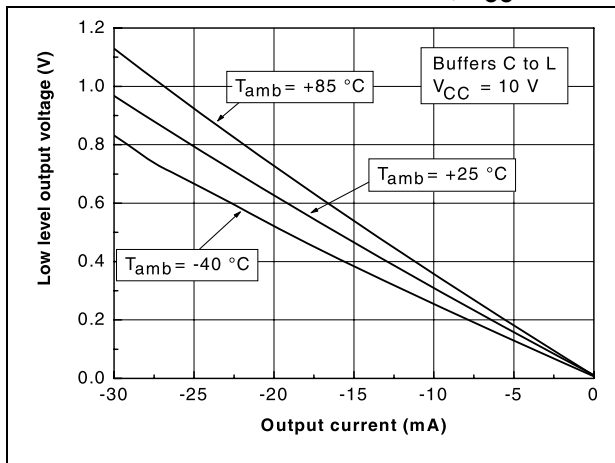


Figure 17. Voltage output low (V_{OL}) vs. output current - buffers C to L, $V_{CC} = 16.8\text{ V}$

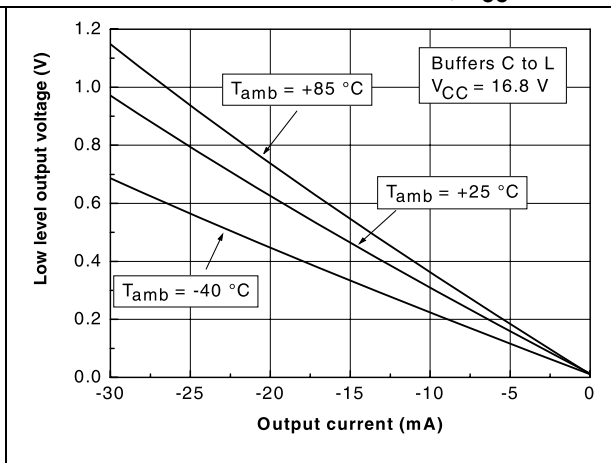


Figure 18. Voltage output low (V_{OL}) vs. output current - buffers M, N and COM, $V_{CC} = 5.5\text{ V}$

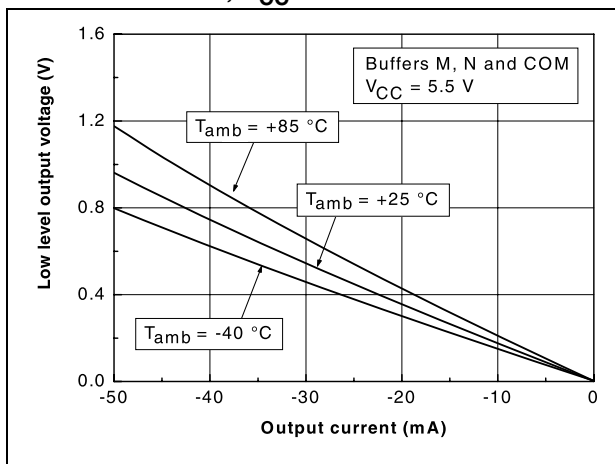


Figure 19. Voltage output low (V_{OL}) vs. output current - buffers M, N and COM, $V_{CC} = 10\text{ V}$

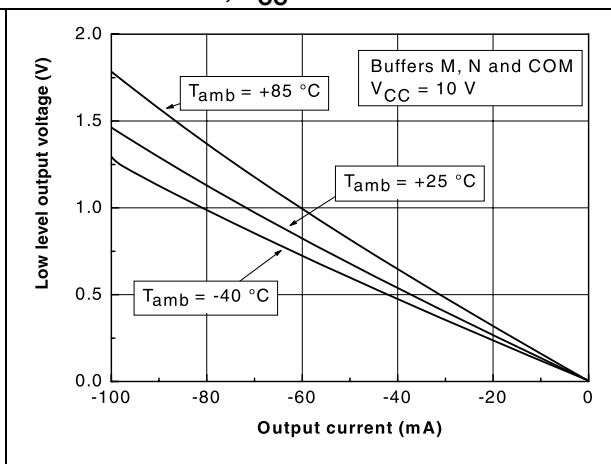


Figure 20. Voltage output low (V_{OL}) vs. output current - buffers M, N and COM, $V_{CC} = 16.8\text{ V}$

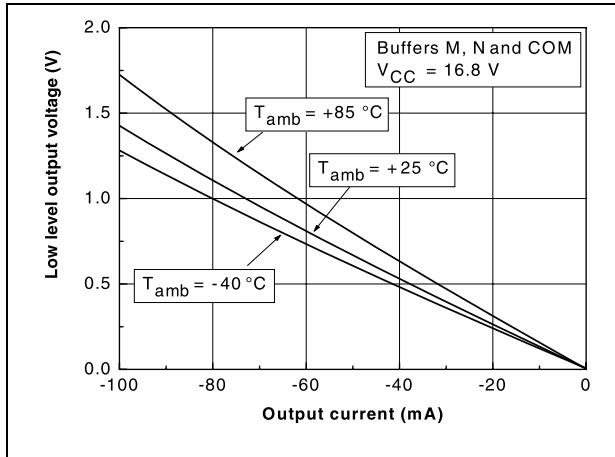


Figure 21. Positive slew rate vs. temperature, $V_{CC} = 5.5\text{ V}$

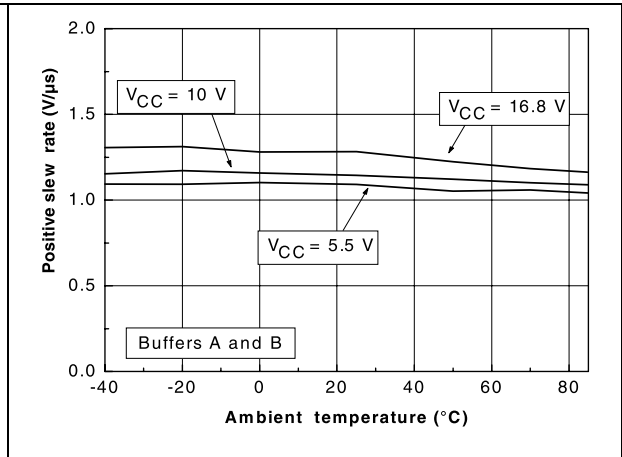


Figure 22. Positive slew rate vs. temperature, $V_{CC} = 10\text{ V}$

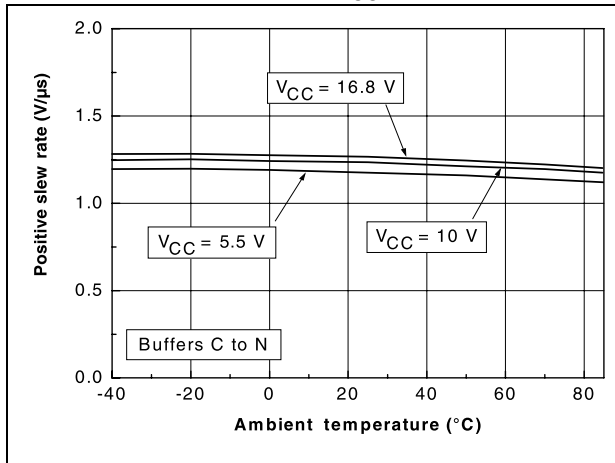


Figure 23. Positive slew rate vs. temperature, $V_{CC} = 16.8\text{ V}$

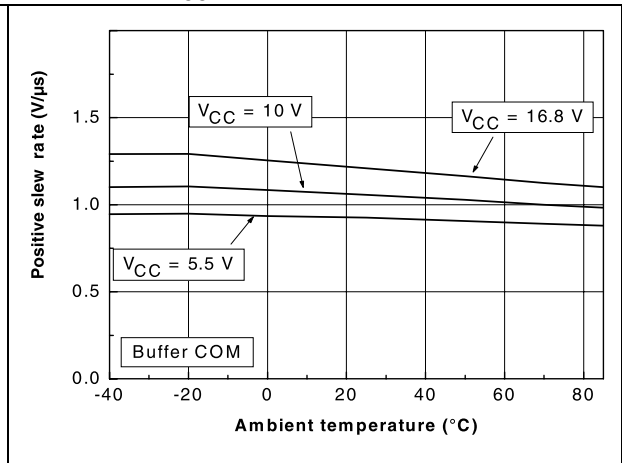


Figure 24. Negative slew rate vs. temperature, buffers A and B

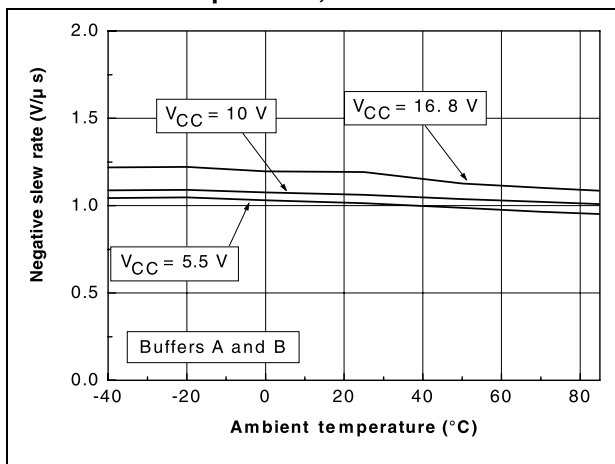


Figure 25. Negative slew rate vs. temperature, buffers C to N

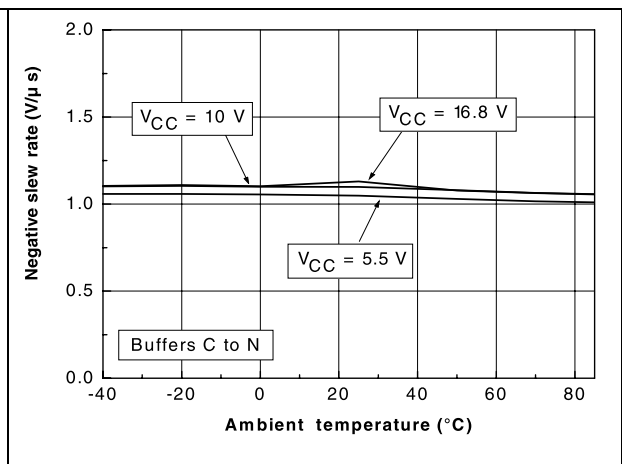


Figure 26. Negative slew rate vs. temperature, buffer COM

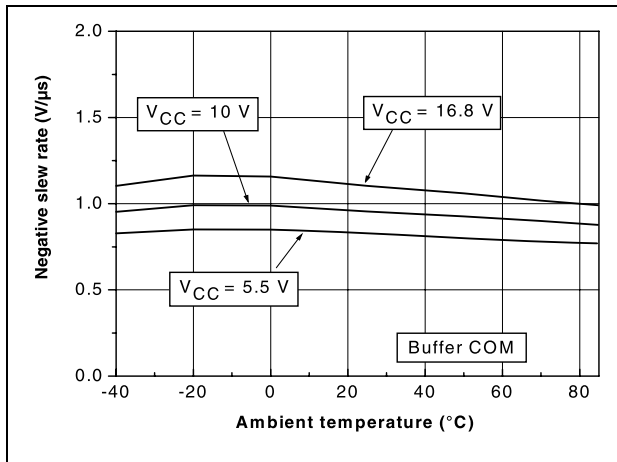


Figure 27. Large signal response - buffers A and B - positive step

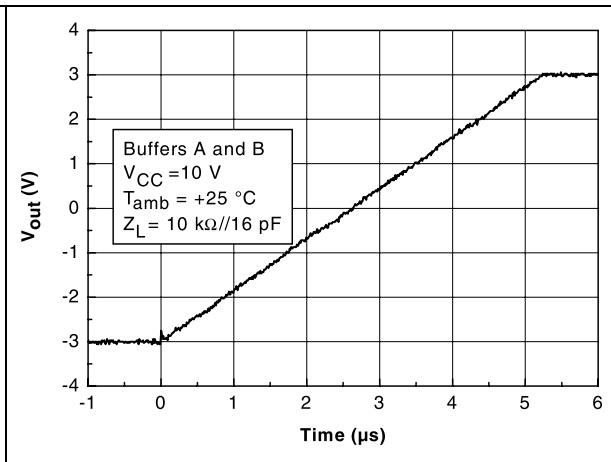


Figure 28. Large signal response - buffers A and B - negative step

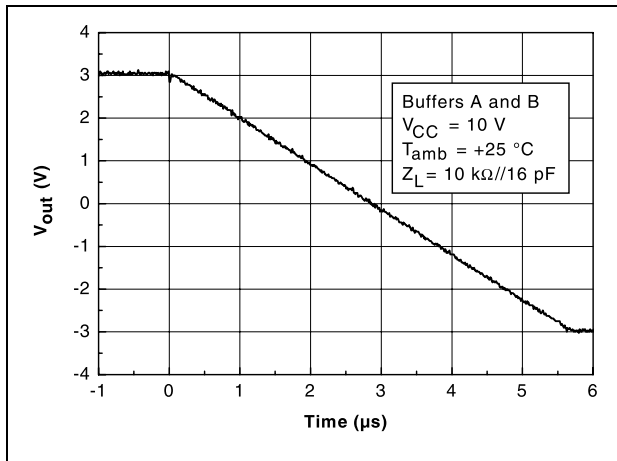


Figure 29. Large signal response - buffers C to N - positive step

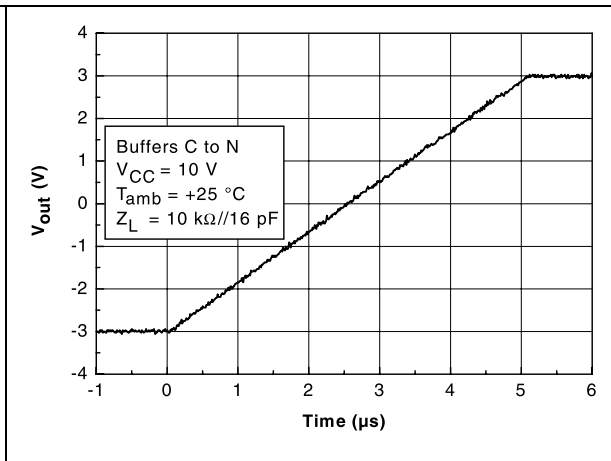


Figure 30. Large signal response - buffers C to N - negative step

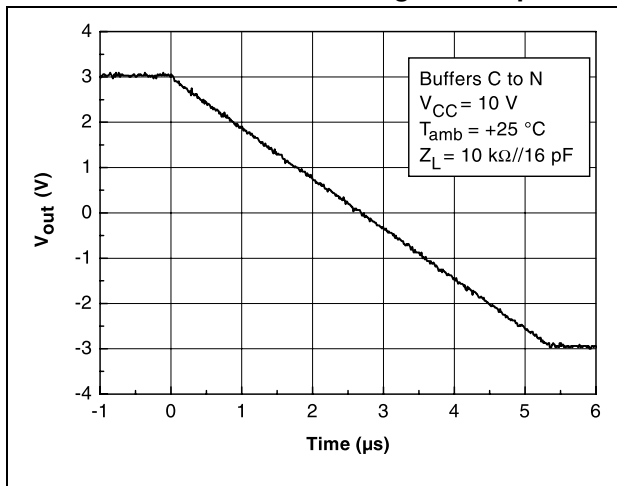


Figure 31. Large signal response - buffer COM - positive step

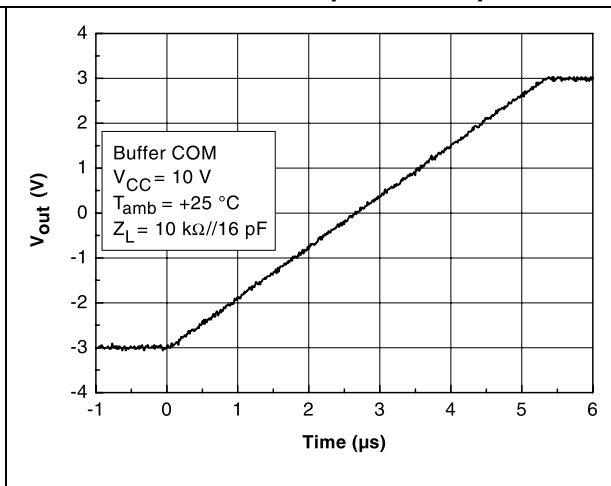


Figure 32. Large signal response - buffer COM - negative step

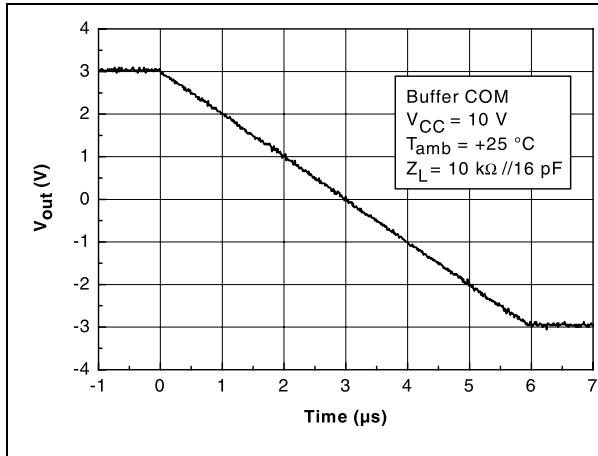


Figure 33. Small signal response - buffers A and B

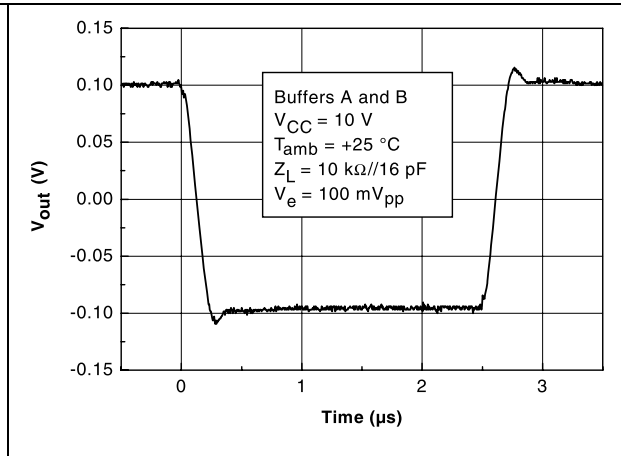


Figure 34. Small signal response - buffers C to N

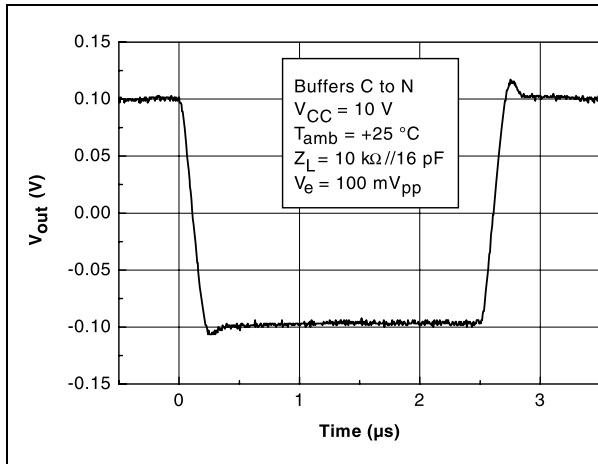


Figure 35. Small signal response - buffer COM

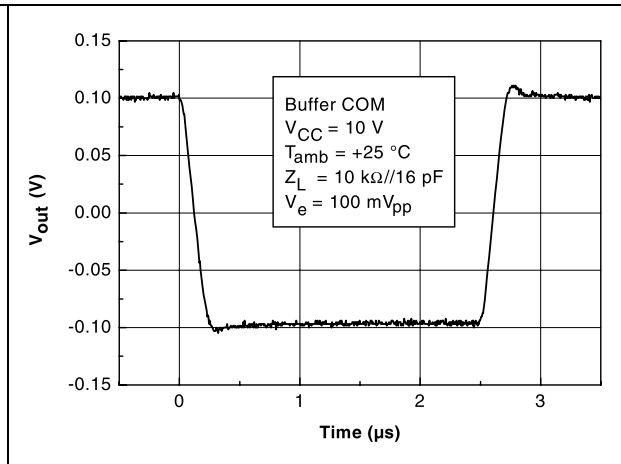


Figure 36. Output voltage response to current transient - buffers A and B, $\Delta I = 0$ to 30 mA

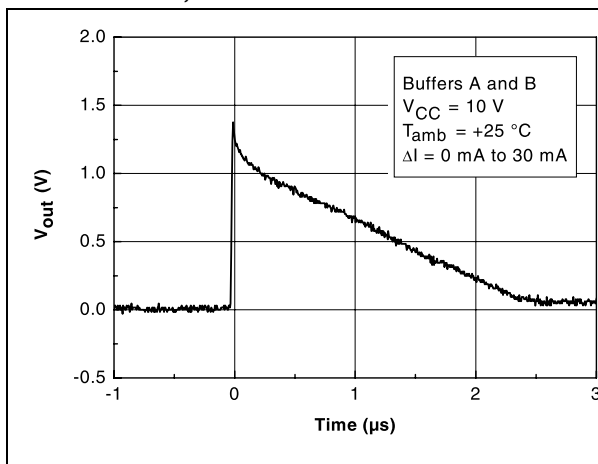


Figure 37. Output voltage response to current transient - buffers A and B, $\Delta I = 30$ to 0 mA

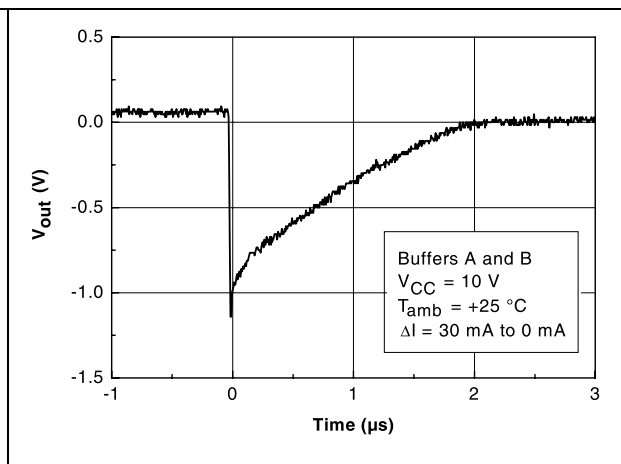


Figure 38. Output voltage response to current transient - buffers C to N, $\Delta I = 0$ to 30 mA

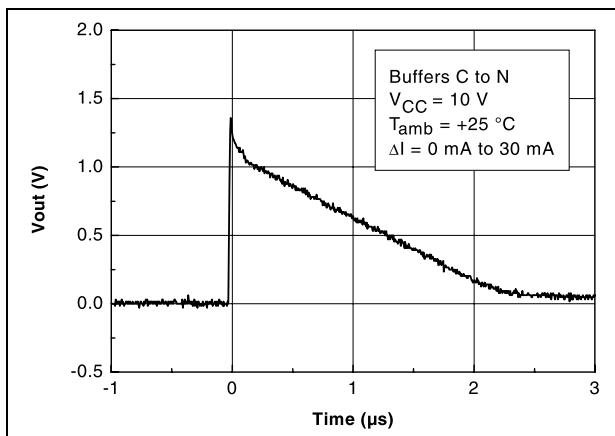


Figure 39. Output voltage response to current transient - buffers C to N, $\Delta I = 30$ to 0 mA

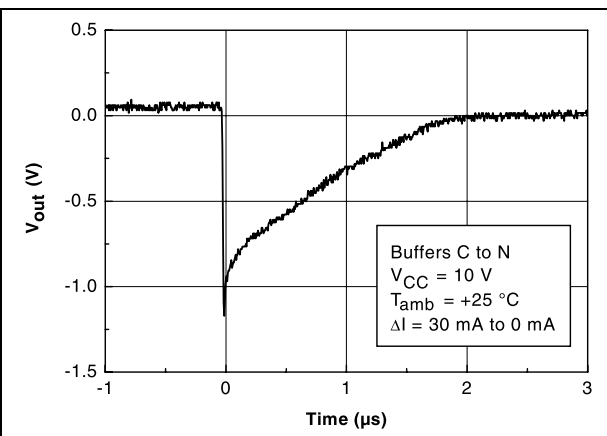


Figure 40. Output voltage response to current transient - buffer COM, $\Delta I = 0$ to 100 mA

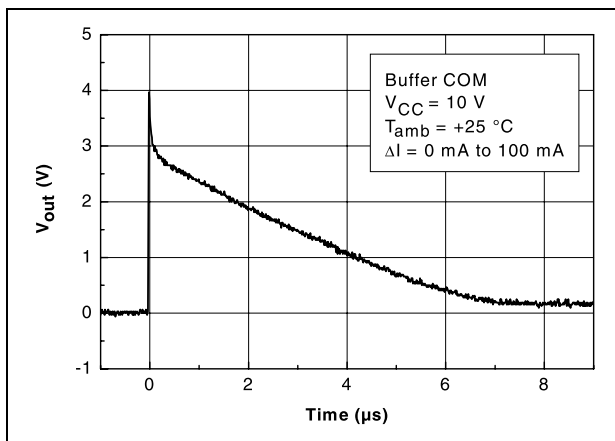


Figure 41. Output voltage response to current transient - buffer COM, $\Delta I = 100$ to 0 mA

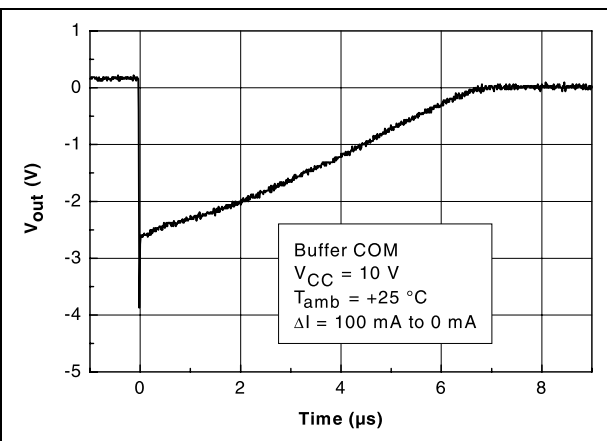


Figure 42. Output voltage response to current transient - buffer COM, $\Delta I = 100$ to -100 mA

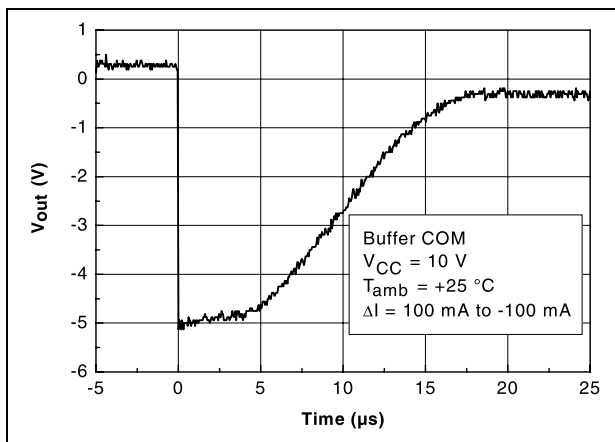
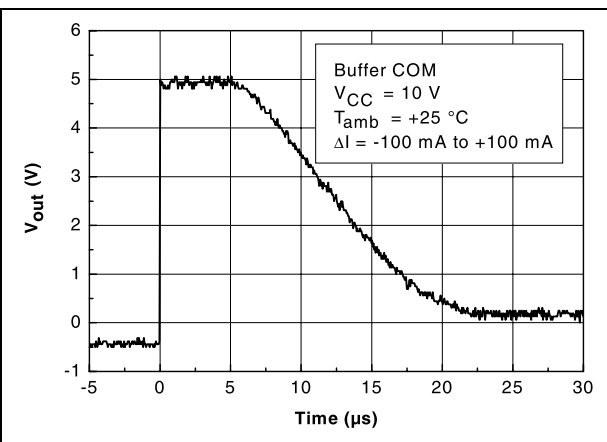


Figure 43. Output voltage response to current transient - buffer COM, $\Delta I = -100$ to +100 mA



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Figure 44. TQFP48 package outline

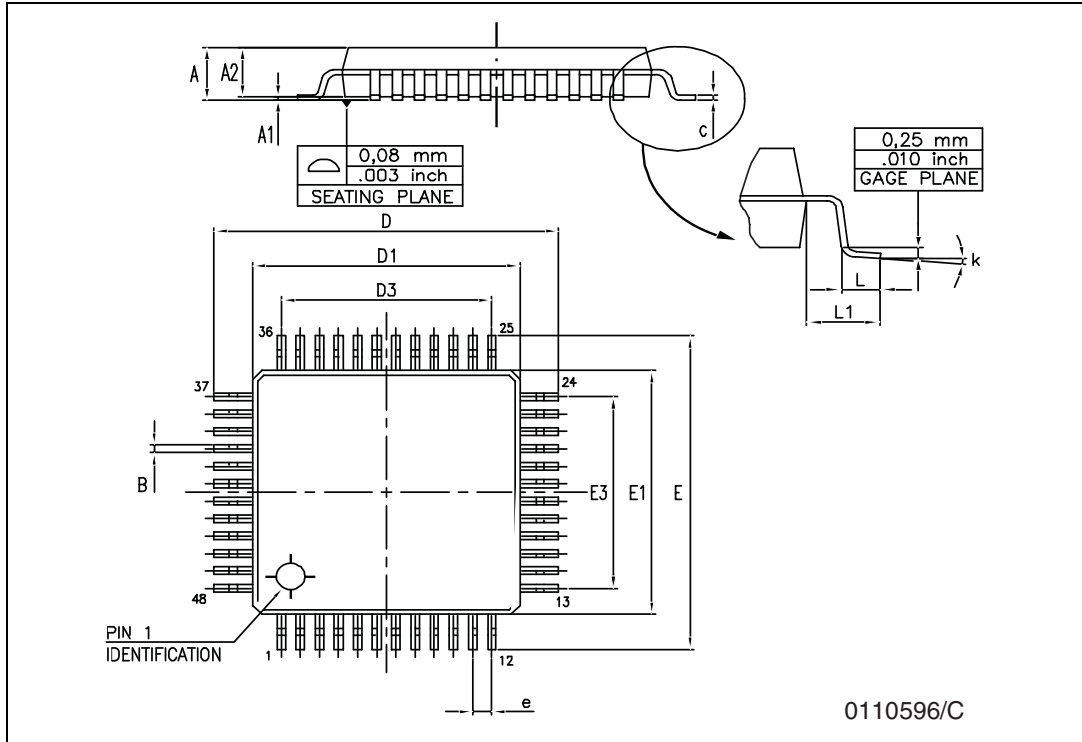


Table 5. TQFP48 package mechanical data

Symbol	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.6			0.063
A1	0.05		0.15	0.002		0.006
A2	1.35	1.40	1.45	0.053	0.055	0.057
B	0.17	0.22	0.27	0.007	0.009	0.011
C	0.09		0.20	0.0035		0.0079
D		9.00			0.354	
D1		7.00			0.276	
D3		5.50			0.216	
e		0.50			0.020	
E		9.00			0.354	
E1		7.00			0.276	
E3		5.50			0.216	
L	0.45	0.60	0.75	0.018	0.024	0.030
L1		1.00			0.039	
K	0°	3.5°	7°	0°	3.5°	7°

5 Ordering information

Table 6. Order codes

Order code	Temperature range	Package	Packing	Marking
TSL1014IF	-40 °C to +85 °C	TQFP48	Tray	SL1014I
TSL1014IFT			Tape and reel	
TSL1014IYFT ⁽¹⁾			Tape and reel	SL1014Y

1. Qualified and characterized according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 and Q 002 or equivalent.

6 Revision history

Table 7. Document revision history

Date	Revision	Changes
01-Jul-2005	1	Initial release - Product in full production.
01-Sep-2005	2	Lead temperature corrected in Table 1 on page 2 . Electrical characteristics graphs re-ordered from Figure 2 on page 6 to Figure 43 on page 12 .
07-Mar-2007	3	Notes added on ESD in Table 1 on page 2 . Maximum operating supply voltage increased in Table 2 on page 2 . Input voltage parameters added in Table 2 on page 2 . V_{OL} limits changed for Buffers C to L in Table 4 on page 5 .
09-Jun-2008	4	Electrical characteristics table added for automotive parts. Order codes added for automotive parts.
19-Aug-2008	5	Modified I_{CC} typical and maximum values for standard parts in Table 3 . Updated all curves (Figure 2 to Figure 43). Added ESD charged device model value in Figure 1 .
11-May-2009	6	Modified footnote under Table 6: Order codes .
14-Nov-2012	7	Removed TSL1014IYF device from Table 4 and Table 6 . Renamed titles of Figure 4 to Figure 8 , Figure 10 to Figure 32 , and Figure 36 to Figure 43 (added conditions). Reformatted Section 4 (added Figure 44). Minor corrections throughout document.

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